

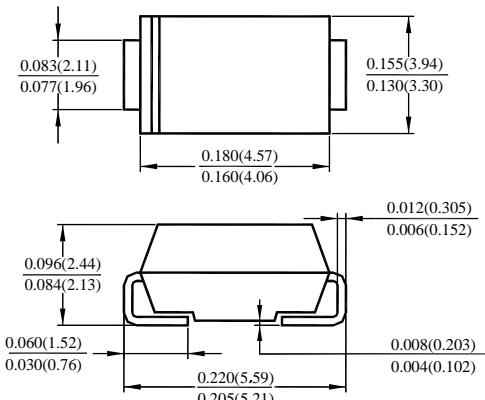
Features

- Plastic package has Underwriters Laboratories Flammability Classification 94V-0
- Metal silicon junction, majority carrier conduction
- For surface mount applications
- Low power loss, high efficiency
- High current capability, Low forward voltage drop.
- Low profile package
- Built-in strain relief, ideal for automated placement
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- High temperature soldering guaranteed:
250/10sec at terminals

Mechanical Data

- **Case:** JEDEC DO-214AA, molded plastic body
- **Terminals:** Solder plated, solderable per MIL-STD-750, Method 2026
- **Polarity:** Color band denotes cathode end

SS32---SS3A



Dimensions in inches and (millimeters)

DO-214AA (SMB)

Absolute Maximum Ratings and Characteristics

Ratings at 25°C ambient temperature unless otherwise specified. Single phase, half wave, resistive or inductive load .For capacitive load , derate by 20%.

	Symbols	SS32	SS33	SS34	SS35	SS36	SS38	SS3A	Units
Maximum repetitive peak reverse voltage	V _{RRM}	20	30	40	50	60	80	100	V
Maximum RMS voltage	V _{RMS}	14	21	28	35	42	57	71	V
Maximum DC blocking voltage	V _{DC}	20	30	40	50	60	80	100	V
Maximum average forward rectified current at 0.375"(9.5mm) lead length	I _{F(AV)}					3.0			A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}					80			A
Maximum Instantaneous forward voltage at 3.0A (Note 1)	V _F		0.50		0.75		0.85		V
Maximum instantaneous reverse Current at rated DC blocking at voltage (Note 1)	I _R I _R			1.5					mA
		20			10				
Typical junction capacitance	C _{tot}		250		160				pF
Typical thermal resistance (Note 2)	R _{θJA} R _{θJA}			55.0					°C/W
				17.0					
Operating junction temperature range	T _J		-65 to +125		-65 to +150				°C
Storage temperature range	T _S			-65 to +150					°C

Notes: 1. Pulse test: 300μs pulse width, 1% duty cycle

2. P.C.B. mounted 0.55X 0.55"(14X14mm) copper pad areas

FIG.1-FORWARD CURRENT DERATING CURVE

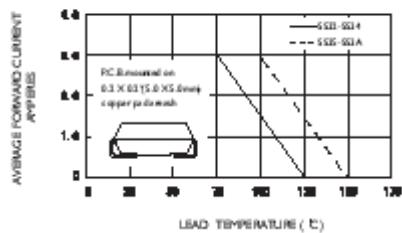


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

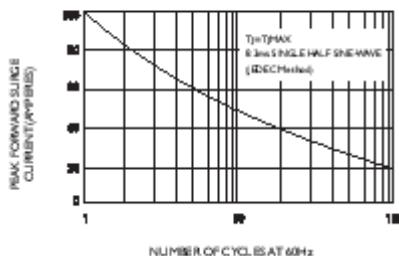


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

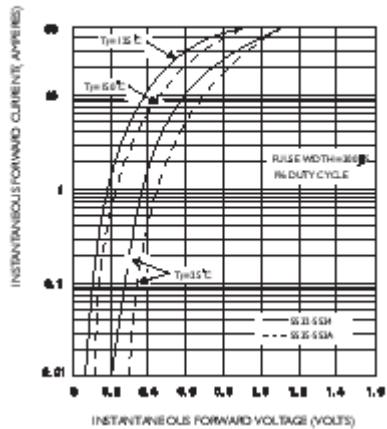


FIG.4-TYPICAL REVERSE CHARACTERISTICS

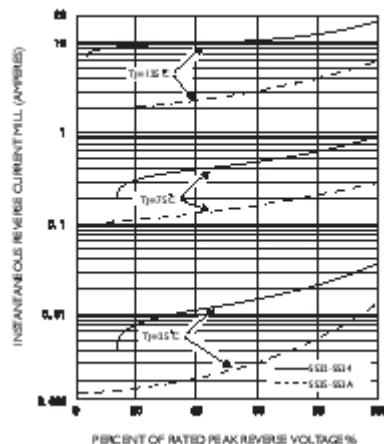


FIG.5-TYPICAL JUNCTION CAPACITANCE

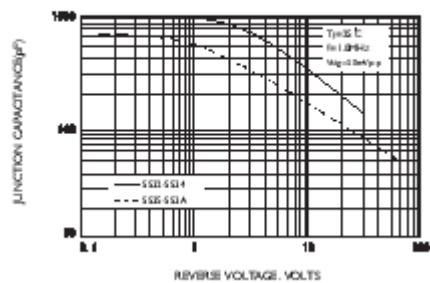


FIG.6-TYPICAL TRANSIENT THERMAL IMPEDANCE

